

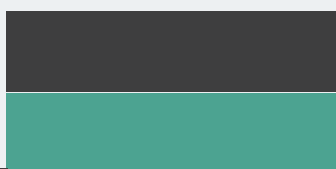
P2250

POLYIMIDE FILM TAPE

茶色高温胶



产品结构 - Product structure



----- 聚酰亚胺膜 - PI Film

----- 硅胶 - Silicon

物性表 - Physical properties table

项目	参数	Project	Parameter
基材	聚酰亚胺膜	Material	PI Film
粘合剂	硅胶	Glue type	Silicon
基材厚度	0.025mm	Material thickness	0.025mm
总厚度	0.05mm	Total thickness	0.05mm
粘着力	4.5N/25mm	Adhesive Strength with 180° Peel	4.5N/25mm
拉力强度	135N/25mm	tensile strength	135N/25mm
伸长率	35%	Elongation	35%
耐温性	-73to260°C	Application temperature	-73to260°C
耐电压	4.5 KW	Voltage resistance	4.5 KW

*Description: the above is only typical test data, the physical properties of the product should not be interpreted as guarantee value.

应用范围 - Range of application

适用于电子线路板波峰焊锡遮蔽、保护金手指和高档电器绝缘、马达绝缘，以及锂电池正负及耳固定特别适用于SMT耐温保护、电子开关、PCB板金手指保护、电子变压器、继电器等各种需耐高温及防潮保护的电子元器件。

Applicable to electronic circuit boards wave soldering tin shelter, protection money fingers and high-grade electrical insulation, motor insulation, as well as the lithium battery positive and negative and ears fixed particularly applicable to SMT and heat-resistant protect goldfinger, electronic switches, PCB, electronic transformers, relays and other high temperature resistance and moisture protection of electronic components.